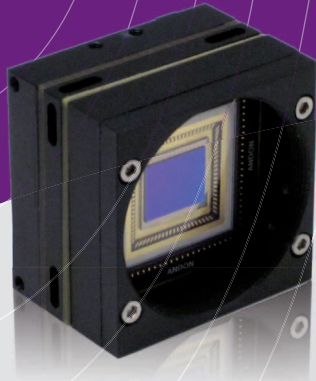


Imagine the invisible

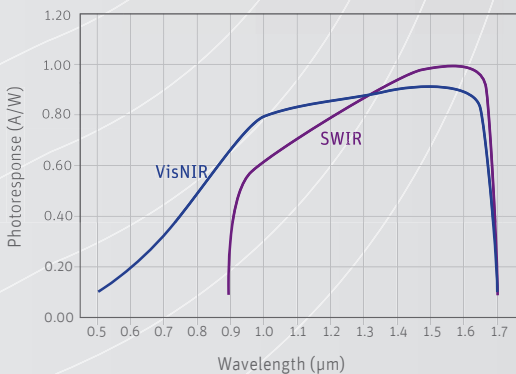
Modules & components

XSW-640

High resolution
TE 1-cooled SWIR OEM module



Ready-to-integrate SWIR OEM module consuming ultra-low-power



Xenics' XSW-640 OEM module is extremely compact and versatile for easy and swift integration in your SWIR imaging configuration.

The XSW-640 OEM module detects short wave infrared radiation between 0.9 and 1.7 µm with a wide dynamic range and wide operating temperature.

Typical OEM applications include infrared imaging for man-portable and unmanned (airborne and land-based) vehicle payloads, night vision, border security, Search & Rescue (SAR) and more.

The Thermo Electric (TE) stabilization reduces the dark current and noise levels. Together with on-board image processing you will have best contrast and high image quality.

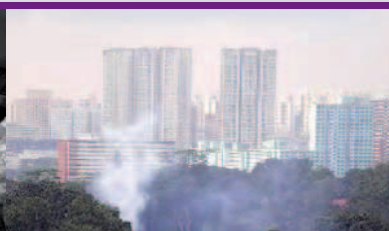
Designed for use in



Person identification



Camouflage detection



Vision enhancement: looking through haze with SWIR



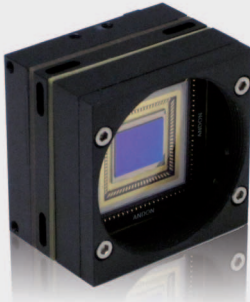
Key features

- Made in Europe
- High resolution
- Easy connectivity
- Small 20 µm pixel pitch

OEM applications

- SWIR sights
- UAV / UGV
- Border security
- Laser detection
- Night vision (passive & active)
- Search & Rescue
- Driver assistance
- Electro optical payloads
- Long range identification
- Enhanced Vision Systems (EVS)

Ready-to-integrate



Specifications

Array Specifications	XSW-640
Array type	InGaAs
Spectral band	0.9 to 1.7 μm (optional 0.6 to 1.7 μm)
# pixels	640 x 512
Pixel pitch	20 μm
Array cooling	TE 1-cooled
Gain mode	CTIA: High and Low Gain
Readout mode	ITR and IWR
Pixel operability	> 99 %
Module Specifications	XSW-640
Lens (not included)	
Optical interface	Fixation holes for multiple lens mount
Imaging performance	
Frame rate	100 Hz
Noise	90 e ⁻ (typical)
A to D conversion resolution	14 bit
Interfaces	
Connector type	Samtec 40 pin QTE
Digital output	Digital output following BT.601-6/BT.656-5 standard Parallel uncompressed video data
Digital control	Serial LVCMOS 3 V interface using XSP protocol
Trigger	In and out
Power requirements	
Power consumption	3 W
Power supply	3.3 V
Physical characteristics	
Shock	70 G, 2 ms halfsine profile
Vibration	4.5 G, (5 Hz to 500 Hz)
Ambient operating temperature	-40 °C to 70 °C
Dimensions	45 W x 45 H x 24 L mm ³
Weight module	70 g

Product selector guide

Part number	Frame rate (Hz)	Interface	VisNIR
XEN-000295	100	16bitDV	No
XEN-000304		BT.656	
XEN-000098		16bitDV	Yes
XEN-000305		BT.656	

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